



## PRODUCT SERIES NAME: A1002 SERIES-DUAL ROW SMT TYPE

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#### 1.SCOPE:

This specification covers the requirements for product performance of 1.00mm pitch wire to board connector series.

## 2.CONSTRUCTION · DIMENSIONS · MATERIAL & PLATING:

See the attached drawings

## **3.RATINGS & APPLICABLE WIRES:**

Item	Standard		
Rated Voltage (max.)	50V AC, DC		
Rated Current (max.)	AWG #28	1A AC, DC	Insulation O.D.
and Applicable Wires	AWG #30	1A AC, DC	0.80mm (max.)
	AWG #32	0.5A AC, DC	
Ambient Temperature Range	-25°C ~ +85°C*		

<sup>\*:</sup> Including terminal temperature rise

#### **4.PERFORMANCE:**

### 4-1.ELECTRICAL PERFORMANCE

Test Description		Procedure	Requirement	
4-1-1	Contact	Mate connectors, measure by dry circuit, 20mV max.,	$20 \mathrm{m}\Omega$ max.	
	Resistance	10mA. (Based upon JIS C5402 5.4)	ZUIIISZ IIIAX.	
4-1-2	Insulation	Mate connectors, apply 500V DC between adjacent		
	Resistance	terminal or ground. (Based upon JIS C5402 5.2/	$100 \mathrm{M}\Omega$ min.	
		MIL-STD-202 Method 302 Cond. B)		
4-1-3	Dielectric	Mate connectors, apply 500V AC (rms) for 1 minute		
	Withstanding	between adjacent terminal or ground. (Based upon	No Breakdown	
	Voltage	JIS C5402 5.1/MIL-STD-202 Method 301)		
4-1-4	Contact	Crimp the applicable wire on to the terminal, measure		
	Resistance	by dry circuit, 20mV max., 10mA.	$5 \mathrm{m}\Omega$ max.	
	on Crimped		Jiiisz Illax.	
	Portion			

			APPROVED	CHECKED	WRITTEN
			BY	BY	BY
A2	REVISE	2008.09.12			
A1	REVISE	2007.06.26	Wu Yu Chun	Lui Can Zhu	Bo Bo Chu
A0	NEW RELEASE	2006.08.15			
REV.	DESCRIPTION	DATE	DOCUMENT NO: PS-1002-002		





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## 4-2.MECHANICAL PERFORMANCE

Test Description Procedure			Requirement	
4-2-1	Insertion & Withdrawal Force	Insert and withdraw connectors at the speed rate of $25 \pm 3$ mm/minute.		Refer to paragraph 5
4-2-2	Crimping	Fix the crimped terminal, apply axial pull out force on the wire at the speed	AWG #28	1.0kgf min.
	Pull Out Force	rate of 25 ± 3mm/minute. (Based upon JIS C5402 6.8)	AWG #30	0.8kgf min.
			AWG #32	0.5kgf min.
4-2-3	Terminal Insertion Force	Insert the crimped terminal into the housing.		0.5kgf max.
4-2-4	Terminal/ Housing Retention Force	Apply axial pull out force at the speed rate of $25 \pm 3$ mm/minute on the terminal assembled in the housing.		0.5kgf min.
4-2-5	Pin Retention Force	Apply axial push force at the speed rate of $25 \pm 3$ mm/minute.		0.5kgf min.
4-2-6	Durability	When mated up to 50 cycles repeatedly by the rate of 10 cycles per minute.  Contact Resistance		40mΩ max.
		Amplitude: 1.5mm P-P Sweep time: 10-55-10 Hz in 1 minute	Appearance	No Damage
4-2-7	Vibration	Duration: 2 hours in each X.Y.Z. axes	Contact Resistance	40m $Ω$ max.
		(Based upon MIL-STD-202 Method 201A)	Discontinuity	1μsec. max.
		490m/s² {50G}, 3 strokes in each X.Y.Z. axes.	Appearance	No Damage
4-2-8	Physical Shock	(Based upon JIS C0041/MIL-STD-202 Method 213B Cond. A)	Contact Resistance	40mΩ max.
			Discontinuity	1μsec. max.





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## 4-3.ENVIRONMENTAL PERFORMANCE AND OTHERS

Test Description		Procedure		Requirement
4-3-1	Temperature Rise	Carrying rated current load. (Based upon UL 498)	Temperature Rise	30°C max.
4-3-2	Heat	$85 \pm 2^{\circ}$ C, 96 hours	Appearance	No Damage
	Resistance	(Based upon JIS C0021/MIL-STD-202	Contact	
		Method 108A Cond. A)	Resistance	$40 \mathrm{m}\Omega$ max.
4-3-3	Cold	$-25 \pm 3$ °C, 96 hours	Appearance	No Damage
	Resistance	(Based upon JIS C0020)	Contact	$40 \mathrm{m}\Omega$ max.
			Resistance	40IIIS2 IIIax.
		Temperature: $40 \pm 2^{\circ}$ C	Appearance	No Damage
		Relative Humidity: 90 ~ 95%	Contact	$40 \mathrm{m}\Omega$ max.
		Duration: 96 hours	Resistance	40111 <u>22 111</u> 8X.
4-3-4	Humidity	(Based upon JIS C0022/MIL-STD-202	Insulation	$10 \mathrm{M}\Omega$ min.
		Method 103B Cond. B)	Resistance	TOWISZ IIIII.
			Dielectric	
			Withstanding	Must meet 4-1-3
			Voltage	
		5 cycles of:	Appearance	No Damage
4-3-5	Temperature	a) - 55°C 30 minutes	Appearance	No Damage
	Cycling	b) +85°C 30 minutes	Contact	$40 \mathrm{m}\Omega$ max.
		(Based upon JIS C0025)	Resistance	Tomse max.
		$24 \pm 4$ hours exposure to a salt spray	Appearance	No Damage
4-3-6	Salt Spray	from the $5 \pm 1\%$ solution at $35 \pm 2$ °C.	rippedianee	110 Bumage
		(Based upon JIS C0023/MIL-STD-202	Contact	$40 \mathrm{m}\Omega$ max.
		Method 101D Cond. B)	Resistance	
		24 hours exposure to $50 \pm 5$ ppm.	Appearance	No Damage
4-3-7	SO <sub>2</sub> Gas	$SO_2$ gas at $40 \pm 2$ °C.	Contact	$40 \mathrm{m}\Omega$ max.
			Resistance	
		40 minutes exposure to NH <sub>3</sub> gas	Appearance	No Damage
4-3-8	NH3 Gas	evaporating from 28% Ammonia	Contact	$40 \mathrm{m}\Omega$ max.
		solution.	Resistance	
		Soldering Time: $5 \pm 0.5$ sec.	Solder	95% of immersed
4-3-9	Solderability	Solder Temperature: $245 \pm 5^{\circ}$ C	Wetting	area must show no
				voids, pin holes
		When reflowing		
4-3-10		Refer to paragraph 6		
	to Soldering		Appearance	No Damage
	Heat	Solder iron method	F F	
		Soldering Time: $5 \pm 0.5$ sec.		
		Solder Temperature: 370°C ~ 400°C		





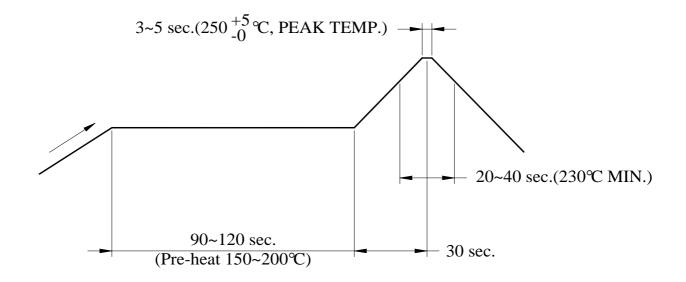
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#### **5.INSERTION/WITHDRAWAL FORCE:**

No. of	Insertion	Withdrawal
circuits	(kgf max.)	(kgf min.)
Single	0.2	0.03
2X06	4.0	1.10
2X08	5.2	1.50
2X09	5.8	1.70
2X10	6.4	1.90
2X15	9.4	2.90
2X20	12.4	3.90
2X25	15.4	4.90

#### **6.INFRARED REFLOW CONDITION:**



# TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)

NOTE: Please check the mount condition(reflow soldering condition) by your own devices beforehand, because the condition changes by the soldering devices, p.c.boards, and so on. No moisture treatment before reflow process.